

# PDP93328BTA11

SMD Type Photo Diode with Daylight Filter

#### Features

- Small double-end package
- High reliability
- High Reverse Breakdown
- High Sensitivity
- Fast Response time
- RoHS compliance

## Applications

Infrared sensor

#### Description

The PDP93328BTA11 is a silicon photo diode housed in a miniature SMD package. The device comes with a superior filtering for visible light by utilizing special black molding compound.

# Package Outline



Schematic





# Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
VR	Reverse Voltage	33	V	
T <sub>opr</sub>	Operating Temperature	-40 ~ +85	٥C	
T <sub>stg</sub>	Storage Temperature	-40 ~ +100	٥C	
T <sub>sol</sub>	Soldering Temperature	260	٥C	1
Pto	Total Power Dissipation	150	mW	

## Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

#### **Optical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
λ	Spectral Bandwidth	-	700	-	1100	nm	
λP	Peak Sensitivity	-	-	940	-	nm	
θ1/2	View Angle	V <sub>R</sub> =5V	-	±55	-	deg	

#### **Electrical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lo	Dark Current	Ee=0mW /cm <sup>2</sup>		-	10	nA	
		V <sub>R</sub> =10V	-				
V <sub>BR</sub>	Deverse Breekdewn Voltege	Ee=0mW /cm <sup>2</sup>	22		N		
	Reverse breakdown vollage	I <sub>R</sub> =100uA	33	33 -	-	v	
Voc	Open-Circuit Voltage	Ee=1mW /cm <sup>2</sup>	-	0.42	-	V	
Isc	Short-Circuit Current	$\lambda_P=940$ nm	-	8.5	-	μA	
I <sub>RL</sub>	Poweree Light Current	Ee=1mW /cm <sup>2</sup>	ΕO	0.6			
	Reverse Light Current	$\lambda_P=940nm, V_R=5V$	5.0 9.0 -	9.0	μΑ		
Ст		Ee=0mW /cm <sup>2</sup>		4 70		- pF	
	Transition Capacitance	f=1MHz ,V <sub>R</sub> =5V	-	4.76	-		



# SMD Type Photo Diode with Daylight Filter

#### **Switching Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
tr	Rise Time	$V_R = 10V, R_L = 10k\Omega$	-	770	-	ns	2
t <sub>f</sub>	Fall Time		-	720	-		

#### Notes:

- 1 : Soldering time  $\leq$  5 seconds.
- 2 : Test circuit :



Switching Time



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# **Typical Characteristic Curves**





# **Typical Characteristic Curves**





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#### Package Dimension All dimensions are in mm, unless otherwise stated





## Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



# **Ordering Information**

Part Number	Description	Quantity
PDP93328BTA11	Tape & Reel	3000 pcs





## Reel Dimension All dimensions are in mm, unless otherwise stated

Tape Dimension All dimensions are in mm, unless otherwise stated





## Label Form Specification



Part no: CTM Production Number Serial no: Production Number Lot no: Lot number Q'ty: Packing Quantity Date Code: Manufacture Date Bin Code: I<sub>RL</sub> Ranks MADE IN CHINA: Production Place

# Storage Condition

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 168h at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



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#### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate ( $T_P$ to $T_L$ )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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